

TrenchT2™ HiperFET™ **Power MOSFET**

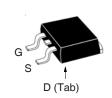
IXFA180N10T2 IXFP180N10T2

N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Rectifier



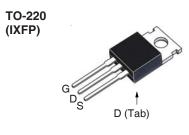
100V 180A $6m\Omega$ $\mathbf{R}_{\mathrm{DS(on)}}$





| Symbol | Test Conditions | Maximum Ra | atings |
|-------------------------------|--|----------------|----------|
| V _{DSS} | T _J = 25°C to 175°C | 100 | V |
| V _{DGR} | $T_J = 25$ °C to 175°C, $R_{GS} = 1M\Omega$ | 100 | V |
| $V_{\rm GSS}$ | Continuous | ±20 | V |
| V _{GSM} | Transient | ±30 | V |
| I _{D25} | T _C = 25°C (Chip Capability) | 180 | A |
| I _{L(RMS)} | External Lead Current Limit | 120 | Α |
| I _{DM} | $T_{\rm C} = 25^{\circ}$ C, Pulse Width Limited by $T_{\rm JM}$ | 450 | Α |
| I _A | T _C = 25°C | 90 | A |
| E _{AS} | $T_{c} = 25^{\circ}C$ | 750 | mJ |
| dV/dt | $I_{_{\mathrm{S}}} \leq I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \leq V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \leq 175^{\circ}\mathrm{C}$ | 15 | V/ns |
| P_{D} | T _C = 25°C | 480 | W |
| T | | -55 +175 | °C |
| T_JM | | 175 | °C |
| T _{stg} | | -55 +175 | °C |
| T, | Maximum Lead Temperature for Soldering | 300 | °C |
| T _{SOLD} | 1.6 mm (0.062in.) from Case for 10s | 260 | °C |
| F _c M _d | 3 (/ | 1065 / 2.214.6 | N/lb |
| M _d | Mounting Torque (TO-220) | 1.13 / 10 | Nm/lb.in |
| Weight | TO-263 | 2.5 | g |
| | TO-220 | 3.0 | g |

| AS | C | | | | |
|----------------------------------|--|--------------------|---------------------|----------|----------------|
| dV/dt | $I_{_{\mathrm{S}}} \leq I_{_{\mathrm{DM}}}, V_{_{\mathrm{DD}}} \leq V_{_{\mathrm{DSS}}}, T_{_{\mathrm{J}}} \leq 175^{\circ}\mathrm{C}$ | | 15 | | V/ns |
| P_{D} | T _C = 25°C | | 480 | | W |
| T _J | | -55 | +175 | | °C |
| T _{JM} | | | 175 | | °C |
| T _{stg} | | -55 | ⊦175 | | °C |
| | Maximum Lead Temperature for Soldering | g | 300 | | °C |
| T _{SOLD} | 1.6 mm (0.062in.) from Case for 10s | | 260 | | °C |
| F _c | Mounting Force (TO-263) Mounting Torque (TO-220) | 1065 / 2.2 1.13 | 14.6 / 10 | Nm/ | N/lb /lb.in |
| Weight | TO-263 TO-220 | | 2.5 3.0 | | g g |
| Symbol (T ₁ = 25°C | Test Conditions Unless Otherwise Specified) | Char Min. | acteristi Typ. | c Values | S |
| BV _{DSS} | $V_{GS} = 0V, I_{D} = 250\mu A$ | 100 | | | V |
| V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 2.0 | | 4.0 | V |
| | V + 00V V 0V | | | 1000 | A |



| G = Gate | D | = | Drain |
|------------|-----|---|-------|
| S = Source | Tab | = | Drain |

Features

- International Standard Packages
- 175°C Operating Temperature
- · High Current Handling Capability
- Fast Intrinsic Rectifier
- Dynamic dV/dt Rated
- Low R_{DS(on)}

Advantages

- · Easy to Mount
- Space Savings
- · High Power Density

Applications

- · Synchronous Rectification
- DC-DC Converters
- Battery Charges
- Switch-Mode and Resonant-Mode **Power Supplies**
- DC Choppers
- AC Motor Drives
- Uninterruptible Power Supplies
- · High Speed Power Switching **Applications**



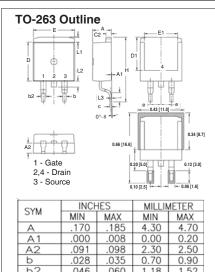
| Symbol Test Conditions (T _J = 25°C Unless Otherwise Specified) | | | Char Min. | acteristic Typ. | c Values Max. |
|--|---|---|--------------|--------------------|------------------|
| g _{fs} | | $V_{DS} = 10V, I_{D} = 60A, Note 1$ | 50 | 88 | S |
| C _{iss} |) | | | 10.5 | nF |
| C _{oss} | } | $V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$ | | 945 | pF |
| \mathbf{C}_{rss} | J | | | 100 | pF |
| t _{d(on)} |) | Resistive Switching Times | | 21 | ns |
| t, | | $V_{GS} = 10V$, $V_{DS} = 0.5 \cdot V_{DSS}$, $I_{D} = 90A$ | | 37 | ns |
| $\mathbf{t}_{d(off)}$ | 1 | $R_{G} = 2\Omega$ (External) | | 34 | ns |
| t _f |) | n _G – 252 (External) | | 13 | ns |
| Q _{g(on)} |) | | | 185 | nC |
| \mathbf{Q}_{gs} | } | $V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 90A$ | | 48 | nC |
| \mathbf{Q}_{gd} | J | | | 52 | nC |
| R _{thJC} | | | | | 0.31 °C/W |
| R _{thCS} | | TO-220 | | 0.50 | °C/W |

Source-Drain Diode

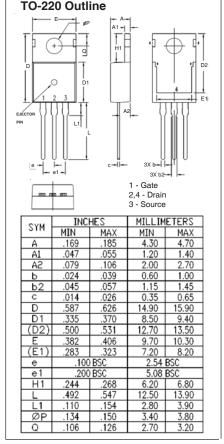
| SymbolTest ConditionsChara(T_ = 25°C Unless Otherwise Specified)Min. | | | acteristic Values Typ. Max. | | |
|--|--|--|----------------------------------|-----|----|
| | | | Typ. | | |
| I _s | $V_{GS} = 0V$ | | | 180 | A |
| SM | Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$ | | | 720 | Α |
| V _{SD} | $I_F = 100A$, $V_{GS} = 0V$, Note 1 | | | 1.3 | V |
| t _{rr} | 1 - 90A V - 0V | | 66 | | ns |
| I _{RM} | $I_F = 90A, V_{GS} = 0V,$ -di/dt = 100A/ μ s, $V_B = 50V$ | | 5.8 | | Α |
| Q _{RM} | -di/dt = 100A/ μ s, V _R = 50V | | 190 | | nC |

Notes: 1. Pulse test, $t \le 300\mu s$; duty cycle, $d \le 2\%$.

2. On through-hole packages, R_{DS(on)} Kelvin test contact location must be 5mm or less from the package body.



| | STW | MIN | MAX | MIN | MAX | | |
|---|----------------|------|-----------------|-----------|-------|--|--|
| | Α | .170 | .185 | 4.30 | 4.70 | | |
| | A1 | .000 | .008 | 0.00 | 0.20 | | |
| | A2 | .091 | .098 | 2.30 | 2.50 | | |
| | Ь | .028 | .035 | 0.70 | 0.90 | | |
| | b2 | .046 | .060 | 1.18 | 1.52 | | |
| | С | .018 | .024 | 0.45 | 0.60 | | |
| | C2 | .049 | .060 | 1.25 | 1.52 | | |
| | D | .340 | .370 | 8.63 | 9.40 | | |
| | D1 | .300 | .327 | 7.62 | 8.30 | | |
| | E | .380 | .410 | 9.65 | 10.41 | | |
| | E1 | .270 | .330 | 6.86 | 8.38 | | |
| | е | .100 | .100 BSC 2.54 B | | BSC | | |
| | Н | .580 | .620 | 14.73 | 15.75 | | |
| | L | .075 | .105 | 1.91 | 2.67 | | |
| | L1 | .039 | .060 | 1.00 | 1.52 | | |
| | L2 | _ | .070 | _ | 1.77 | | |
| | L3 | .010 | BSC | 0.254 BSC | | | |
| | | | | | | | |
| - | | | | | | | |
| • | TO-220 Outline | | | | | | |







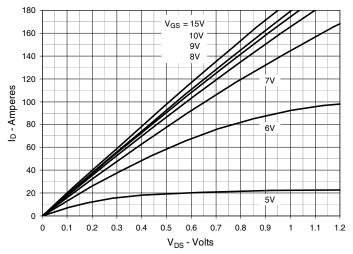


Fig. 2. Extended Output Characteristics @ T_J = 25°C

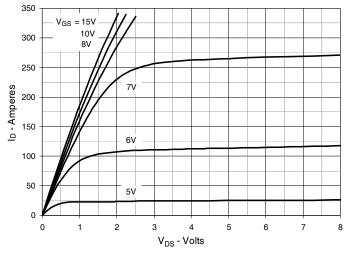


Fig. 3. Output Characteristics @ T_J = 150°C

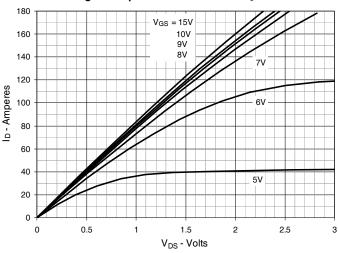


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 90A Value vs. Junction Temperature

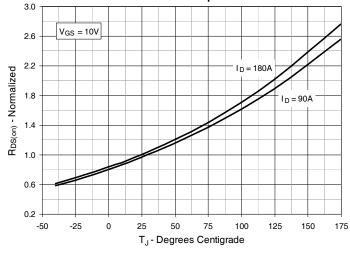


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 90A Value vs.

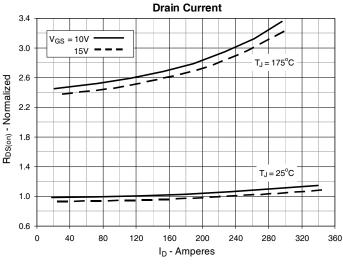
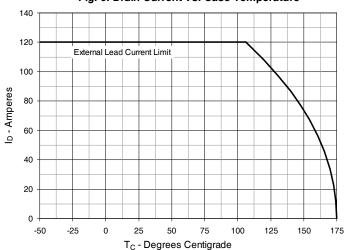
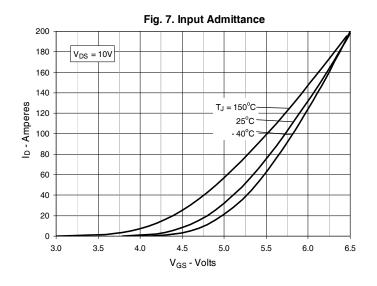
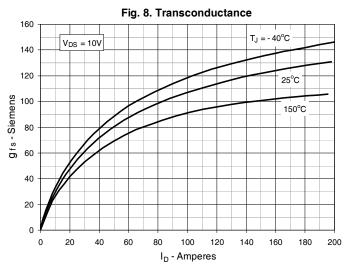


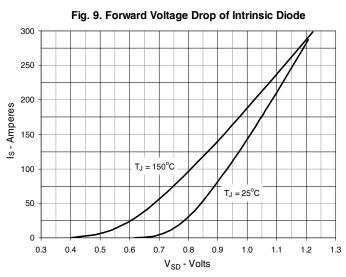
Fig. 6. Drain Current vs. Case Temperature

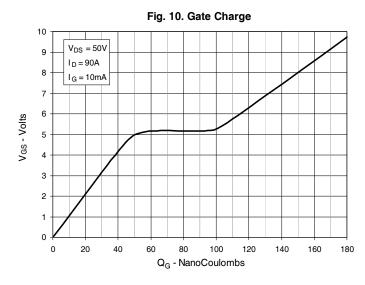


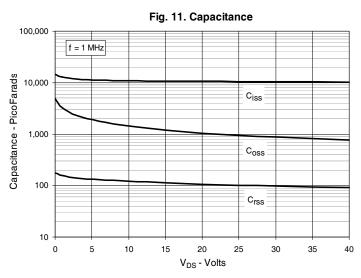


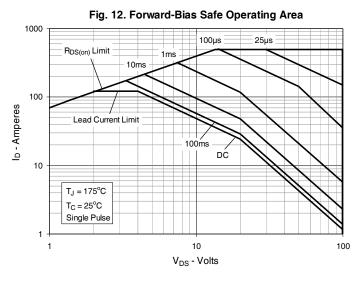












IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.



Fig. 13. Resistive Turn-on Rise Time vs. **Junction Temperature** 50 45 $R_G = 2\Omega$, $V_{GS} = 10V$ V_{DS} = 50V 40 35 tr-Nanoseconds 30 25 20 15 I_D = 45A 10 5 35 45 65 95 105 125 25 75 85 115

Fig. 15. Resistive Turn-on Switching Times vs.
Gate Resistance

T_J - Degrees Centigrade

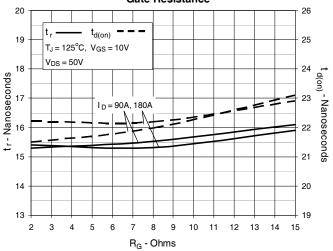


Fig. 17. Resistive Turn-off Switching Times vs.

Drain Current

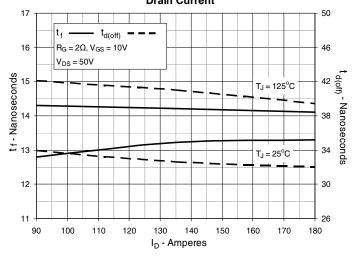


Fig. 14. Resistive Turn-on Rise Time vs.

Drain Current

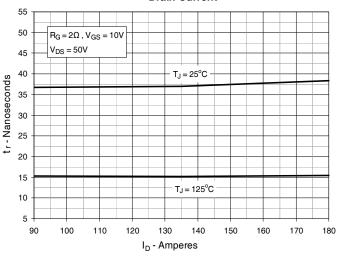


Fig. 16. Resistive Turn-off Switching Times vs.
Junction Temperature

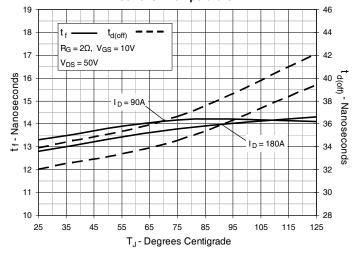
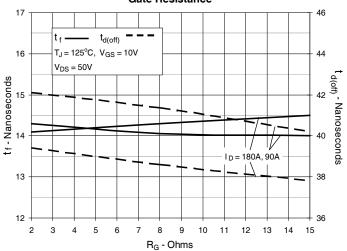


Fig. 18. Resistive Turn-off Switching Times vs.

Gate Resistance





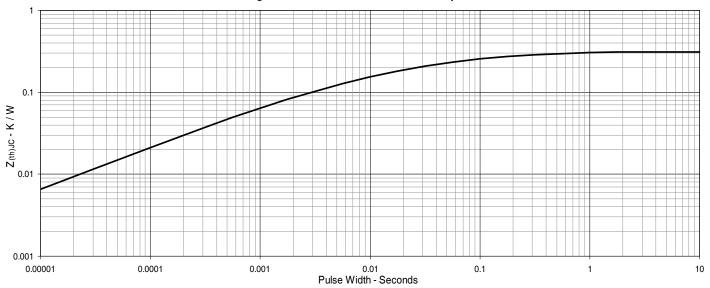


Fig. 19. Maximum Transient Thermal Impedance



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